

# HSP

**NOTES:**

Current Rating: 3.0AMP  
 Withstand Voltage: 500V AC/DC  
 Contact Resistance: 20mΩ Max  
 Insulation Resistance: 1000MΩMin  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA6T+30%G, F UL94V-0

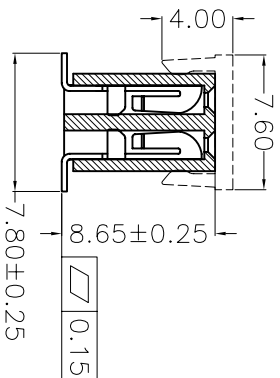
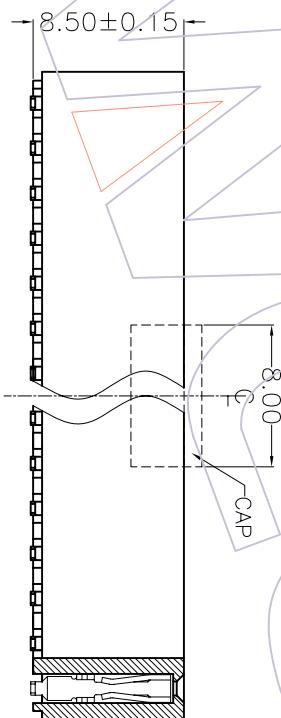
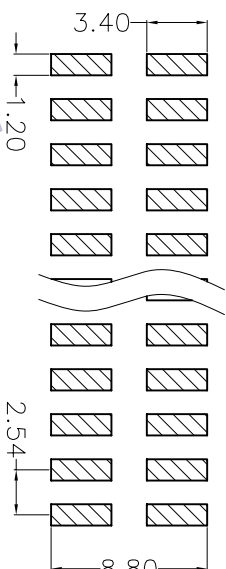
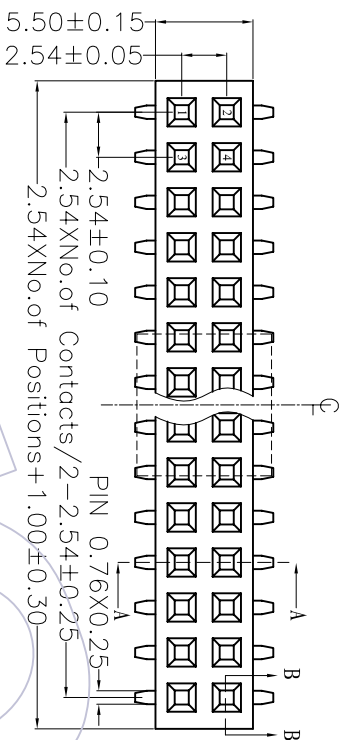
## Ordering Information

2185 - 2 XX M XX C U N X 1

No. of Pins per ROW: 02-40PIN

Contact Plating:  
 GO=Gold Flash  
 GH=3μ"Gold  
 GS=5μ"Gold  
 G3=10μ"Gold  
 G4=15μ"Gold  
 GS=30μ"Gold  
 S0=Gold Flash/Tin  
 S1=3μ"Gold/Tin  
 S2=5μ"Gold/Tin  
 S4=10μ"Gold/Tin  
 S5=15μ"Gold/Tin  
 SS=30μ"Gold/Tin  
 SN=Tin

Packing:  
 T=Tube  
 P=Tube+CAP  
 R=Tube&Resist+CAP



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	08.03.12	SCALE	2.5:1	 <b>WCON</b> 维峰五金电子有限公司 WAFER HARDWARE ELECTRONICS CO.,LTD	PART NO.	2185-2XXMXXCUNX1
A0	08/03/12	NEW			XXX	DESIGN		UNIT	mm	A4		TITLE:	FH2.54 DUAL SMT H=8.5
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	Angle	CHECK		SIZE	1/1	PROJ.	Customer NO.		
1					± 3'	APPROVE		SHEET					